

PC922

High Power OPIC Photocoupler

- ※ Lead forming type (I type) and tapping reel type (P type) are also available. (**PC922I/PC922P**)
- ※※ TÜV (VDE 0884) approved type is also available as an option.

■ Features

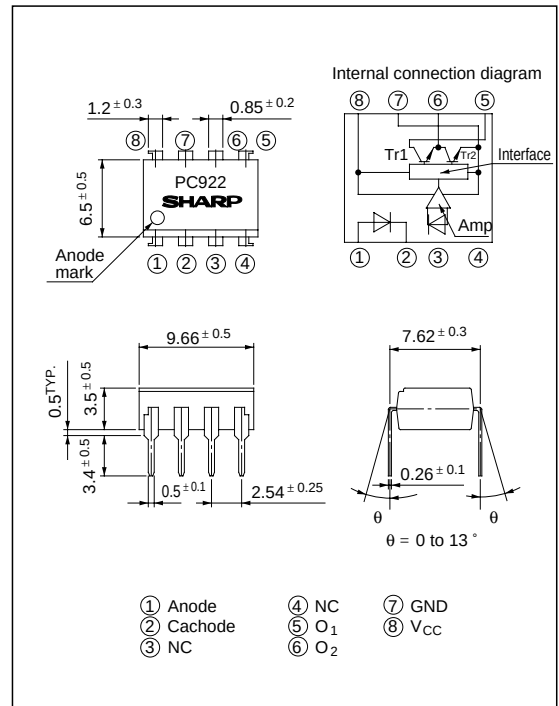
1. Built-in base amplifier for inverter drive
2. High power (I_{O1} : MAX. 0.5A (DC)
(I_{O2P} : MAX. 2.0A (pulse))
3. High isolation voltage between input and output (V_{iso} : 5 000V_{rms})
4. High noise reduction type
5. High speed response (t_{PHL} , t_{PLH} : MAX. 5 μ s)
6. High sensitivity (I_{FLH} : MAX. 3mA)
7. Recognized by UL, file No. E64380

■ Applications

1. Inverter controlled air conditioners
2. Small capacitance general purpose inverters

■ Outline Dimensions

(Unit : mm)



* “ OPIC ” (Optical IC) is a trademark of the SHARP Corporation.
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Absolute Maximum Ratings

(Ta = T_{opr} unless otherwise specified)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_F	25	mA
	*1 Reverse voltage	V_R	6	V
Output	Supply voltage	V_{CC}	18	V
	O ₁ output current	I_{O1}	0.5	A
	*2 O ₁ peak output current	I_{O1P}	1.0	A
	O ₂ output current	I_{O2}	0.6	A
	*2 O ₂ peak output current	I_{O2P}	2.0	A
	O ₁ output voltage	V_{O1}	18	V
	Power dissipation	P_O	500	mW
	Total power dissipation	P_{tot}	550	mW
	*3 Isolation voltage	V_{iso}	5 000	V _{rms}
	Operating temperature	T_{opr}	- 20 to + 80	°C
	Storage temperature	T_{stg}	- 55 to + 125	°C
	*4 Soldering temperature	T_{sol}	260	°C

*1 Ta = 25°C

*2 Pulse width ≤ 5 μ s, Duty ratio: 0.01*3 40 to 60% RH, AC for 1 minute,
Ta = 25°C

*4 For 10 seconds

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■ Electro-optical Characteristics

(Ta = T_{opr} unless otherwise specified)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	Fig.	
Input	Forward voltage	V _{F1}	T _a = 25°C, I _F = 5mA	-	1.1	1.4	V	-	
		V _{F2}	T _a = 25°C, I _F = 0.2mA	0.6	0.9	-	V	-	
	Reverse current	I _R	T _a = 25°C, V _R = 3V	-	-	10	μ A	-	
	Terminal capacitance	C _t	T _a = 25°C, V = 0, f = 1kHz	-	30	250	pF	-	
Output	Operating supply voltage	V _{CC}		5.4	-	13	V	-	
	O ₁ low level output voltage	V _{O1L}	V _{CC} = 6V, I _{O1} = 0.4A, R _{L2} = 10Ω, I _F = 5mA	-	0.2	0.4	V	1	
	O ₂ high level output voltage	V _{O2H}	V _{CC} = 6V, I _{O2} = - 0.4A, I _F = 5mA	4.5	5.0	-	V	2	
	O ₂ low level output voltage	V _{O2L}	V _{CC} = 6V, I _{O2} = 0.5A, I _F = 0	-	0.2	0.4	V	-	
	O ₁ leak current	I _{O1L}	V _{CC} = 13V, I _F = 0	-	-	200	μ A	3	
	O ₂ leak current	I _{O2L}	V _{CC} = 13V, I _F = 5mA	-	-	200	μ A	4	
	High level supply current	I _{CCH}	T _a = 25°C, V _{CC} = 6V, I _F = 5mA	-	9	13	mA	-	
			V _{CC} = 6V, I _F = 5mA	-	-	17	mA	-	
Low level supply current	I _{CCL}	T _a = 25°C, V _{CC} = 6V, I _F = 0	-	11	15	mA	-		
		V _{CC} = 6V, I _F = 0	-	-	20	mA	-		
Transfer characteristics	“5 “ Low→High ” threshold input current		I _{FLH}	T _a = 25°C, V _{CC} = 6V, R _{L1} = 5Ω, R _{L2} = 10Ω	0.3	1.5	3.0	mA	5
				V _{CC} = 6V, R _{L1} = 5Ω R _{L2} = 10Ω	0.2	-	5.0	mA	5
	Isolation resistance		R _{ISO}	Ta = 25°C, DC = 500V 40 to 60% RH	5 x10 ¹⁰	10 ¹¹	-	Ω	-
	Response time	“Low→High” propagation delay time		t _{PLH}	-	2	5	μ s	6
		“High→Low” propagation delay time		t _{PHL}	-	2	5	μ s	
		Rise time		t _r	-	0.2	1	μ s	
		Fall time		t _f	-	0.1	1	μ s	
	Instantaneous common mode rejection voltage “Output : High level”		CM _H	T _a = 25°C, V _{CM} = 600V ^(peak) I _F = 5mA, R _{L1} = 470Ω, R _{L2} = 1kΩ, Δ V _{O2H} = 0.5V	-1 500	-	-	V/ μ s	7
Instantaneous common mode rejection voltage “Output : Low level”		CM _L	T _a = 25°C, V _{CM} = 600V ^(peak) I _F = 0, R _{L1} = 470Ω, R _{L2} = 1kΩ Δ V _{O2L} = 0.5V	1 500	-	-	V/ μ s	7	

*5 I_{FLH} represents forward current when output goes from low to high.

■ Truth Table

Input	O ₂ Output	Tr. 1	Tr. 2
ON	High level	ON	OFF
OFF	Low level	OFF	ON

■ Test Circuit

Fig. 1

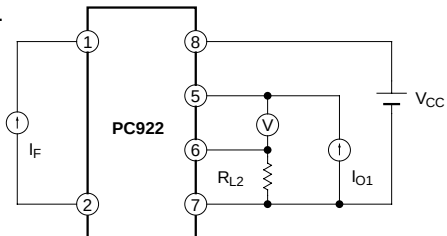


Fig. 3

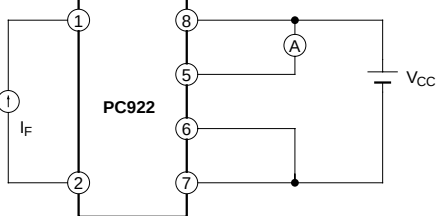


Fig. 5

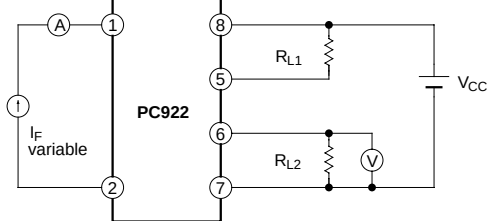


Fig. 7

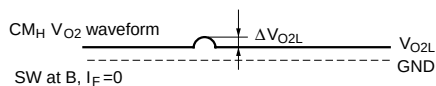
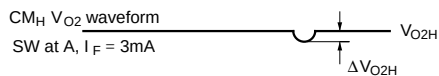
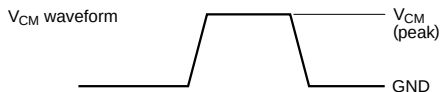
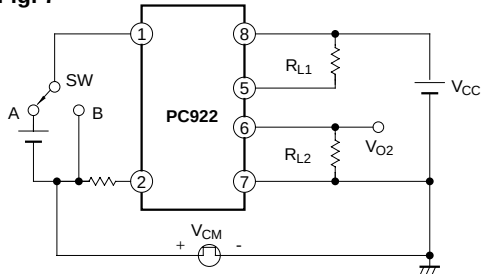


Fig. 2

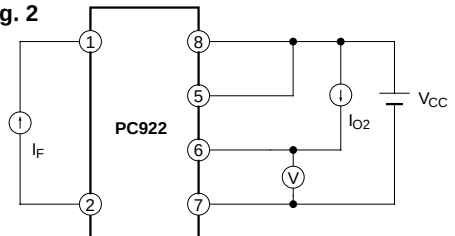


Fig. 4

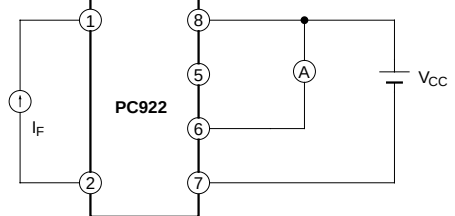


Fig. 6

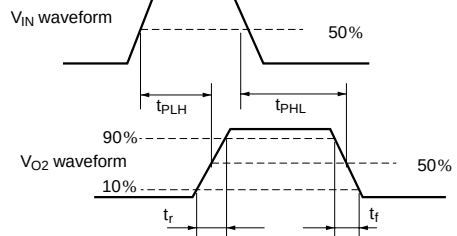
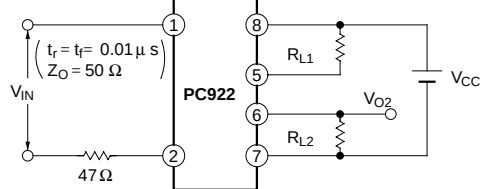


Fig. 8 Forward Current vs. Ambient Temperature

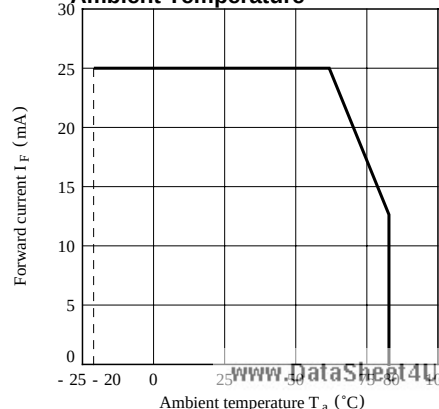


Fig. 9-a Power Dissipation vs. Ambient Temperature

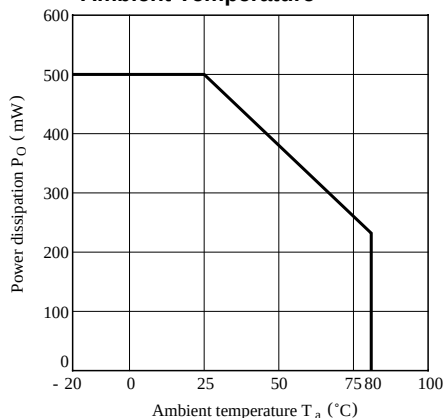


Fig. 9-b Power Dissipation vs. Ambient Temperature

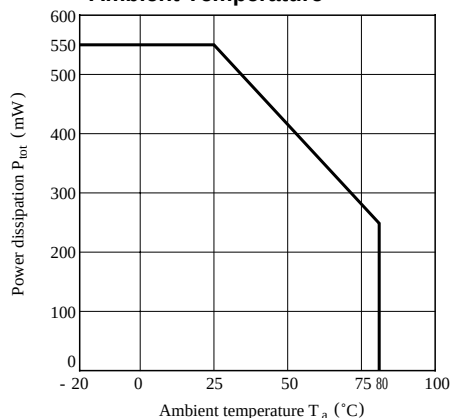


Fig. 10 Forward Current vs. Forward Voltage

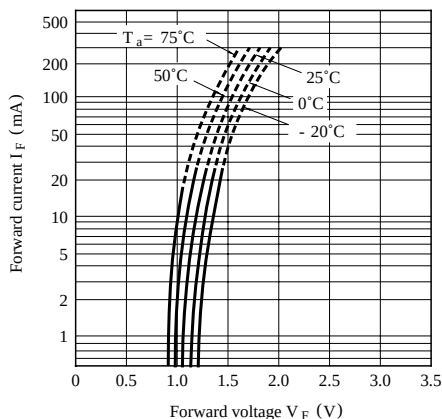


Fig. 12 “Low→High” Relative Threshold Input Current vs. Ambient Temperature

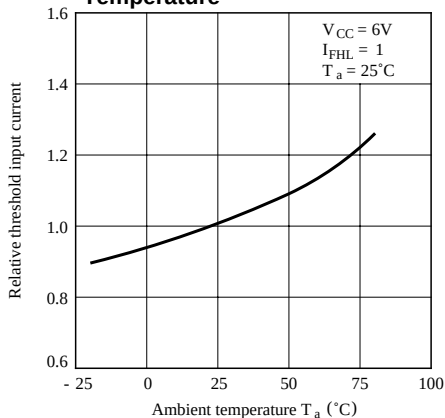


Fig. 11 “Low→High” Relative Threshold Input Current vs. Supply Voltage

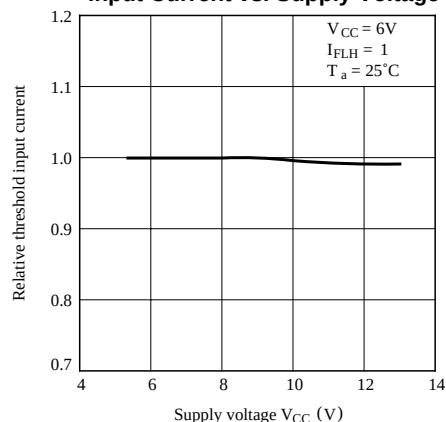


Fig. 13 O_1 Low Level Output Voltage vs. O_1 Output Current

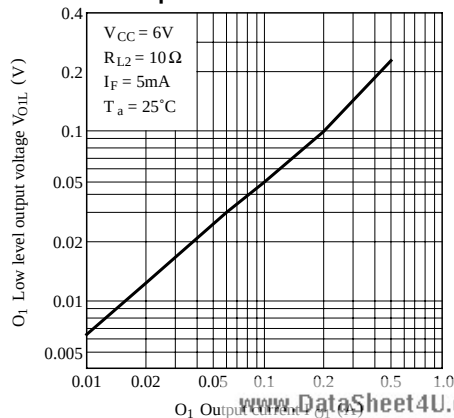


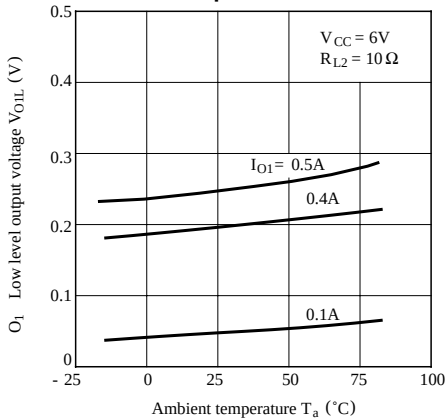
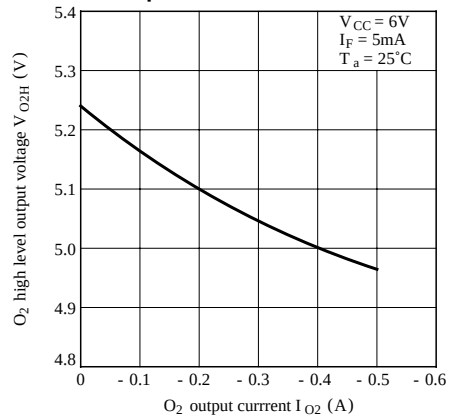
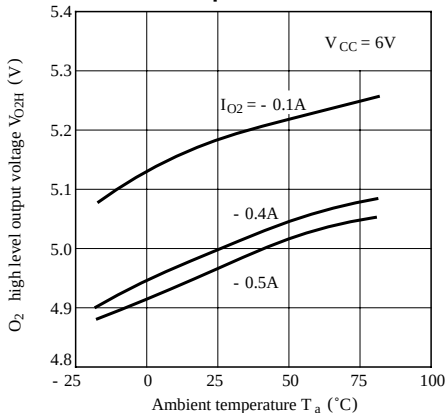
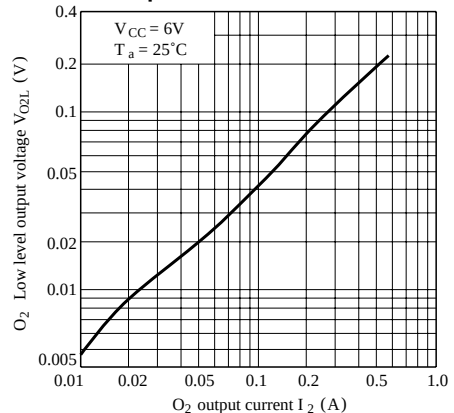
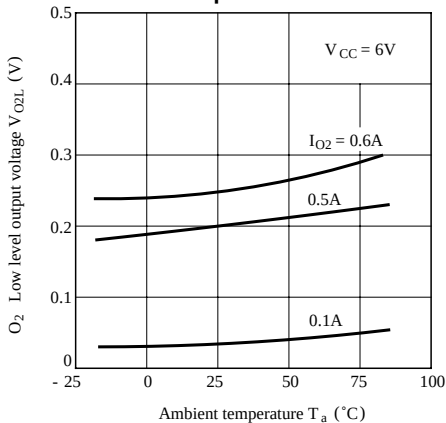
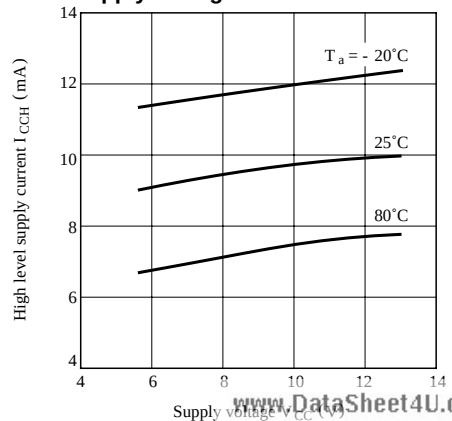
Fig.14 O₁ Low Level Output Voltage vs. Ambient Temperature**Fig.15 O₂ High Level Output Voltage vs. O₂ Output Current****Fig.16 O₂ High Level Output Voltage vs. Ambient Temperature****Fig.17 O₂ Low Level Output Voltage vs. O₂ Output Current****Fig.18 O₂ Low Level Output Voltage vs. Ambient Temperature****Fig.19 High Level Supply Current vs. Supply Voltage**

Fig.20 Low Level Supply Current vs. Supply Voltage

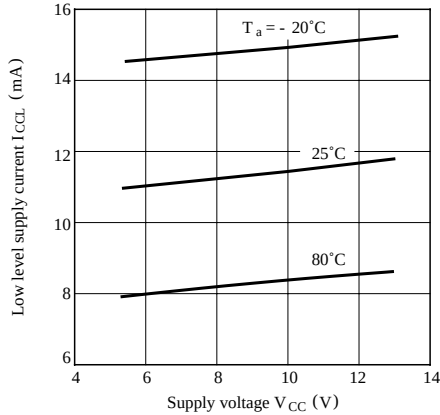


Fig.21 Propagation Delay Time vs. Forward Current

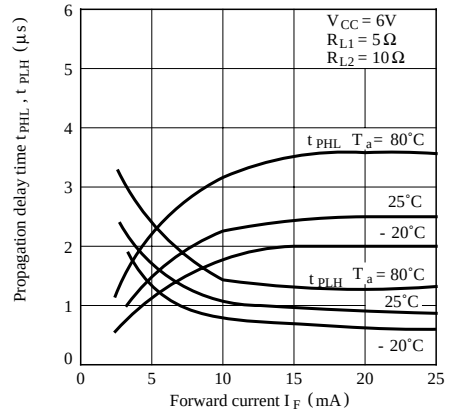
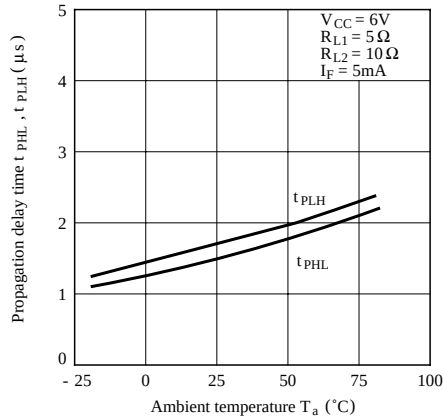
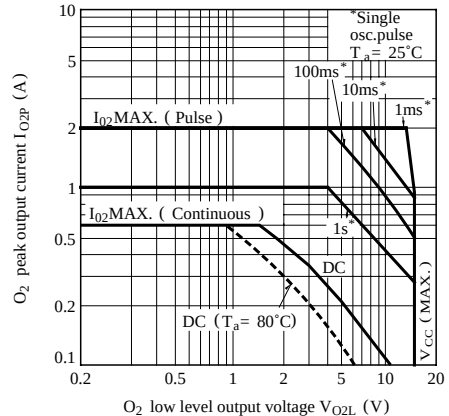
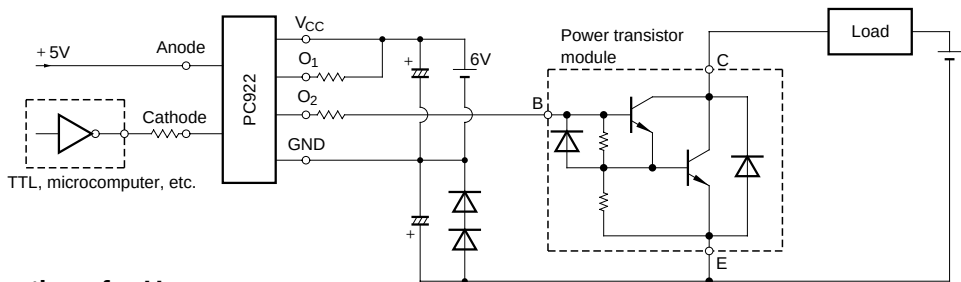


Fig.22 Propagation Delay Time vs. Ambient Temperature

Fig.23 O_2 Peak Output Current vs. O_2 Low Level Output Voltage

Application Circuit



Precautions for Use

- (1) It is recommended that a by-pass capacitor of more than $0.01 \mu\text{F}$ is added between V_{CC} and GND near the device in order to stabilize power supply line.
- (2) Handle this product the same as with other integrated circuits against static electricity.
- (3) As for other general cautions, refer to the chapter "Precautions for Use".